	Туре	Hits	Search Text	DBs	Time Stamp
1	IS&R	621	(228/103).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:29
2	IS&R	187	(228/105).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 11:23
3	IS&R	912	(228/180.5).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 13:07
4	IS&R	175	(228/218).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 13:13
5	IS&R	662	(228/219).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 13:40
6	IS&R	1347	(228/4.5).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:07
7	IS&R	412	(228/8).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:09
8	IS&R	455	(228/9).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:10
9	IS&R	2	(("6824037") or ("6234376")).PN.	USPAT	2005/06/27 14:21

	Туре	Hits	Search Text	DBs	Time Stamp
			("4575602"		
			"4976393"		,
			"5110032"		
4.0			"5285949"	US-PGPUB; USPAT; USOCR	
10	BRS	7	"5538176"	USOCR	2005/06/27 14:21
			"6068174"		
			"6234376").PN. OR		
			("6824037").URPN.		
			("3627978"		
			"3643321"		
			"4098447"		
			"4323759"		
			"4390771"		
			"4476366" i		
			"4564734"		
			"4575602"		
			"4594493"		
			"4732313"		
			"4861533"		
11	BRS	27	"4889274"	US-PGPUB; USPAT;	
• •	DKS	21	"4909427"	USOCR	2005/06/27 14:24
			"4976393"		
			"5249732"		
		. 1	"5393948"	1	
			"5395037"		
			"5433371"		
			"5538176"		
			"5685476"		
			"5816480"		
			"5958259"		
			"6001724").PN. OR		
			("6234376").URPN.		*

	Туре	Hits	Search Text	DBs	Time Stamp
12	IS&R	3952 2	("228").CLAS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:29
13	IS&R	1210 82	("219").CLAS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:29
14	IS&R	8199 2	("356"). CLAS .	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:30
15	IS&R	1059 38	("359"). CLAS .	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:30
16	IS&R	6049 2	("348").CLAS.	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:30
17	BRS	3952 21	\$12 or \$13 or \$14 or \$15 or \$16	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:30
18	BRS	1875 6	\$17 and ((semiconductor or chip or integrated or circuit or substrate) near100 (mount\$3 or wire or bond\$3 or solder\$3 or weld\$3)) and (illuminat\$3 or light)	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:35

	Туре	Hits	Search Text	DBs	Time Stamp
19	BRS	6753	\$17 and ((semiconductor or chip or integrated or circuit or substrate) near100 (mount\$3 or wire or bond\$3 or solder\$3 or weld\$3)) and (illuminat\$3 or light) and (shield\$3 or inert or gas)	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:36
20	BRS	6334	or wire or bond\$3 or solder\$3 or weld\$3\\	US-PGPUB; USPAT;	2005/06/27 14:36

	Туре	Hits	Search Text	DBs	Time Stamp
21	BRS	1059	\$17 and ((semiconductor or chip or integrated or circuit or substrate) near100 (mount\$3 or wire or bond\$3 or solder\$3 or weld\$3)) and (mount\$3 or bond\$3) and (illuminat\$3 or light) and ((shield\$3 or inert) near10 gas)	US-PGPUB; USPAT;	2005/06/27 14:37
22	BRS	321	S17 and ((semiconductor or chip or integrated or circuit or substrate) near100 (mount\$3 or wire or bond\$3 or solder\$3 or weld\$3)) and ((mount\$3 or bond\$3) near100 (illuminat\$3 or light)) and ((shield\$3 or inert) near10 gas)	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:38

	Туре	Hits	Search Text	DBs	Time Stamp
23	BRS	320	\$17 and ((semiconductor or chip or integrated or circuit or substrate) near50 (mount\$3 or wire or bond\$3 or solder\$3 or weld\$3)) and ((mount\$3 or bond\$3) near50 (illuminat\$3 or light)) and ((shield\$3 or inert) near10 gas)	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:38
24	BRS	9	\$17 and ((semiconductor or chip or integrated or circuit or substrate) near50 (mount\$3 or wire or bond\$3 or solder\$3 or weld\$3)) and (((mount\$3 or bond\$3) near50 (illuminat\$3 or light)) near100 ((shield\$3 or inert) near10 gas))	US-PGPUB; USPAT;	2005/06/27 14:39

	Туре	Hits	Search Text	DBs	Time Stamp
25	BRS	303	Dongos or solderos	DERWENT	2005/06/27 14:40
26	BRS	294	or solderss or weld\$3)) and	DERWENT	2005/06/27 14:41

	Туре	Hits	Search Text	DBs	Time Stamp
27	BRS	269	\$17 and ((semiconductor or chip or circuit or substrate) near50 (mount\$3 or bond\$3 or solder\$3)) and ((mount\$3 or bond\$3) near50 (illuminat\$3 or light)) and ((shield\$3 or inert) near10 gas)	EPO; JPO; DERWENT	2005/06/27 14:41
28	BRS	106	near200 ((mount\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:41

	Туре	Hits	Search Text	DBs	Time Stamp
29	BRS	106	or solderson	DERWENT	2005/06/27 14:42
30	BRS	104	near100 ((mount\$3	DERWENT	2005/06/27 14:42

	Туре	Hits	Search Text	DBs	Time Stamp
31	BRS	104	or solderasii nearsii	DERWENT	2005/06/27 14:42
32	BRS	98	or solders sil nearsil	DERWENT	2005/06/27 14:42

	Туре	Hits	Search Text	DBs	Time Stamp
33	BRS	87	or solderaali nearau	DERWENT	2005/06/27 14:43
34	BRS	940	(((semiconductor or chip or circuit or substrate) near10 (mount\$3 or bond\$3 or solder\$3)) near20 ((mount\$3 or bond\$3) near20 (illuminat\$3 or light)) and ((shield\$3 or inert) near10 gas))	EPO; JPO; DERWENT	2005/06/27 14:43

	Туре	Hits	Search Text	DBs	Time Stamp
35	BRS	85	or solder53)) near20	US-PGPUB; USPAT; EPO; JPO; DERWENT	2005/06/27 14:43